

群創光電 PRODUCT SPECIFICATION

Doc. Number:

Tentative Specification
Preliminary Specification
Approval Specification

MODEL NO.: N173HCE SUFFIX: E31

Customer:	
APPROVED BY	SIGNATURE
Name / Title Note	
Please return 1 copy for your corsignature and comments.	ifirmation with your

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2014-11-06	2014-10-30	2014-10-30	
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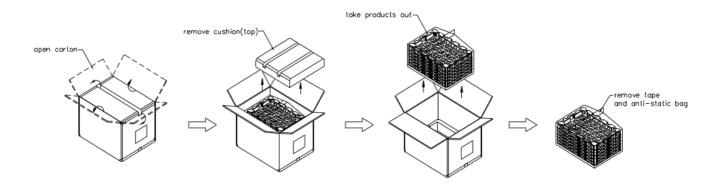
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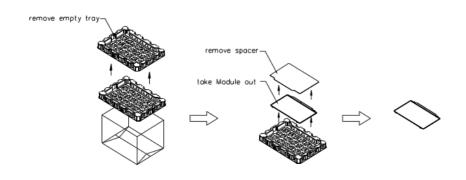


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REVISION HISTORY

Version	Date	Page	Description
0.0	Oct.28, 2014	All	Spec Ver.0.0 was first issued.

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1. GENERAL DESCRIPTION

1.1 OVERVIEW

N173HCE-E31 is a 17.3" TFT Liquid Crystal Display module with LED Backlight unit and 30 pins eDP interface. This module supports 1920 x 1080 FHD model and can display 262,144 colors. The optimum viewing angle is at 6 o'clock direction.

1.2 GENERAL SPECIFICATIONS

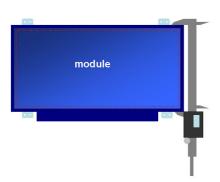
Item	Specification	Unit	Note
Screen Size	17.3" diagonal		
Driver Element	a-si TFT active matrix	-	-
Pixel Number	1920 x R.G.B. x 1080	pixel	-
Pixel Pitch	0.1989 (H) x 0.1989 (V)	mm	-
Pixel Arrangement	RGB vertical stripe	-	-
Display Colors	262,144	color	-
Transmissive Mode	Normally black	-	-
Surface Treatment	Hard coating (3H), High resolution Adaptable AG	-	ı
Luminance, White	300	Cd/m2	
Power Consumption	Total TBD W (Max.) @ cell TBD W (Max.), BL TBD	W (Max.)	

Note (1) The specified power consumption (with converter efficiency) is under the conditions at VCCS = 3.3 V, fv = 60 Hz, LED_VCCS = Typ, fPWM = 200 Hz, Duty=100% and Ta = $25 \pm 2 \,^{\circ}\text{C}$, whereas mosaic pattern is displayed.

2. MECHANICAL SPECIFICATIONS

Item		Min.	Тур.	Max.	Unit	Note	
	Horizontal (H)	399.00	399.50	400.00	mm	(4)	
Module Size	Vertical (V)	229.95	230.45	230.95	mm	(1) (2)	
	Thickness (T)	-	3.57	4.00	mm	(2)	
Danal Area	Horizontal	NA	NA	NA	mm		
Bezel Area	Vertical	NA	NA	NA	mm		
Active Area	Horizontal	381.79	381.89	381.99	mm		
Active Area	Vertical	214.71	214.81	214.91	mm		
Glass	CF	0.45	0.5	0.55	mm		
Thickness	TFT	0.45	0.5	0.55	mm		
\	Veight	-	527	550	g		

Note (1) Please refer to the attached drawings for more information of front and back outline dimensions.

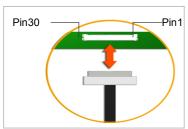


Note (2) Dimensions are measured by caliper.

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2.1 CONNECTOR TYPE



Please refer Appendix Outline Drawing for detail design.

Connector Part No.: IPEX-20455-030E-12 or Tyco 5-2069716-2

User's connector Part No: IPEX-20453-030T-03

3. ABSOLUTE MAXIMUM RATINGS

3.1 ABSOLUTE RATINGS OF ENVIRONMENT

Item	Symbol	Va	Unit	Note		
item	Syllibol	Min.	Max.	Offic	Note	
Storage Temperature	T _{ST}	-20	+60	°C	(1)	
Operating Ambient Temperature	T _{OP}	0	+50	°C	(1), (2)	

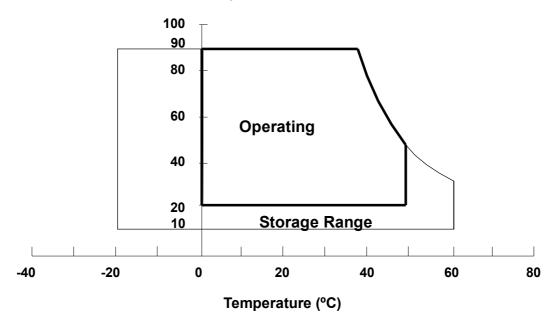
Note (1) (a) 90 %RH Max. (Ta < 40 °C).

(b) Wet-bulb temperature should be 39 °C Max.

(c) No condensation.

Note (2) The temperature of panel surface should be 0 °C min. and 60 °C max.

Relative Humidity (%RH)





3.2 ELECTRICAL ABSOLUTE RATINGS

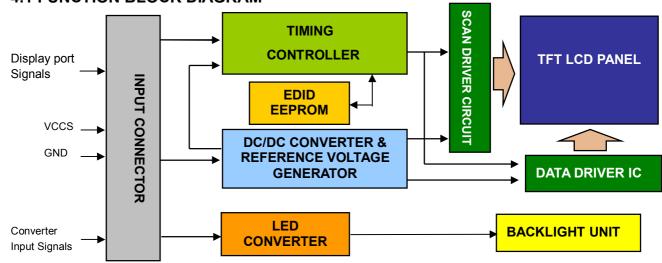
3.2.1 TFT LCD MODULE

Item	Symbol	Va	lue	Unit	Note	
item	Cymbol	Min.	Max.	Offic	14016	
Power Supply Voltage	VCCS	-0.3	+4.0	V	(1)	
Logic Input Voltage	V _{IN}	-0.3	VCCS+0.3	V	(1)	
Converter Input Voltage	LED_VCCS	-0.3	(26)	V	(1)	
Converter Control Signal Voltage	LED_PWM,	-0.3	(5)	V	(1)	
Converter Control Signal Voltage	LED_EN	-0.3	(5)	V	(1)	

Note (1) Stresses beyond those listed in above "ELECTRICAL ABSOLUTE RATINGS" may cause permanent damage to the device. Normal operation should be restricted to the conditions described in "ELECTRICAL CHARACTERISTICS".

4. ELECTRICAL SPECIFICATIONS

4.1 FUNCTION BLOCK DIAGRAM



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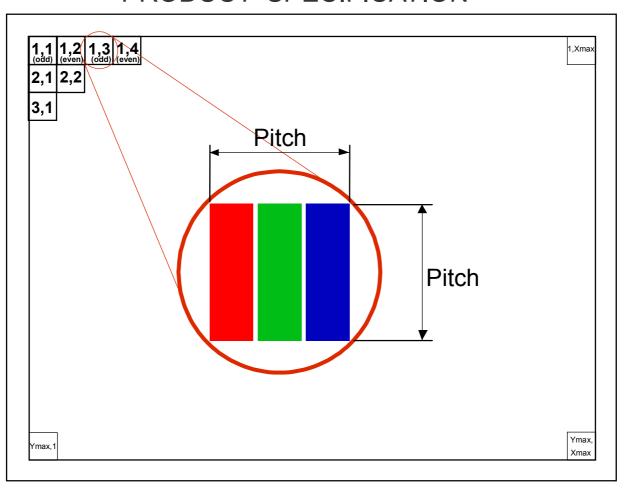
4.2. INTERFACE CONNECTIONS

PIN ASSIGNMENT

Pin	Symbol	Description	Remark
1	NC	No Connection (Reserved for LCD test)	
2	H_GND	High Speed Ground	
3	ML1-	Complement Signal-Lane 1	
4	ML1+	True Signal-Main Lane 1	
5	H_GND	High Speed Ground	
6	ML0-	Complement Signal-Lane 0	
7	ML0+	True Signal-Main Lane 0	
8	H_GND	High Speed Ground	
9	AUX+	True Signal-Auxiliary Channel	
10	AUX-	Complement Signal-Auxiliary Channel	
11	H_GND	High Speed Ground	
12	VCCS	Power Supply +3.3 V (typical)	
13	VCCS	Power Supply +3.3 V (typical)	
14	NC	No Connection (Reserved for LCD test)	
15	GND	Ground	
16	GND	Ground	
17	HPD	Hot Plug Detect	
18	BL_GND	BL Ground	
19	BL_GND	BL Ground	
20	BL_GND	BL Ground	
21	BL_GND	BL Ground	
22	LED_EN	BL_Enable Signal of LED Converter	
23	LED_PWM	PWM Dimming Control Signal of LED Converter	
24	NC	No Connection (Reserved for LCD test)	
25	NC	No Connection (Reserved for LCD test)	
26	LED_VCCS	BL Power	
27	LED_VCCS	BL Power	
28	LED_VCCS	BL Power	
29	LED_VCCS	BL Power	
30	NC	No Connection (Reserved for LCD test)	

Note (1) The first pixel is odd as shown in the following figure.





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4.3 ELECTRICAL CHARACTERISTICS

4.3.1 LCD ELETRONICS SPECIFICATION

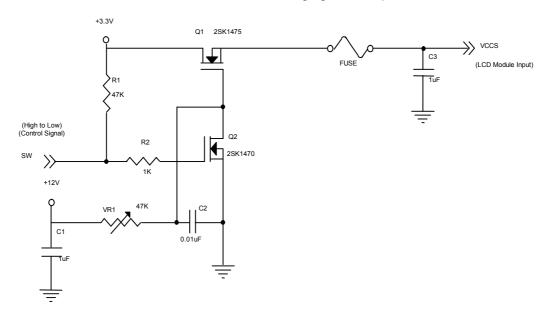
Parameter			Symbol		Value	Unit	Note	
			Syllibol	Min.	Тур.	Max.	Offic	NOIC
Power Supply Voltage			vccs	3.0	3.3	3.6	V	(1)
HPD	High Level			2.25	-	2.75	V	(4)
INFU	Low Level			0	-	0.4	V	(4)
HPD Impedance			R _{HPD}	30K			ohm	(4)
Ripple Voltage			V_{RP}	-	50	-	mV	(1)
Inrush Current			I _{RUSH}	-	-	1.5	Α	(1),(2)
Mosaic		Mosaic	loo		(TBD)	(TBD)	mA	(3)a
Power Supply Curre	TIL	Black	lcc		(TBD)	(TBD)	mA	(3)

Note (1) The ambient temperature is $Ta = 25 \pm 2$ °C.

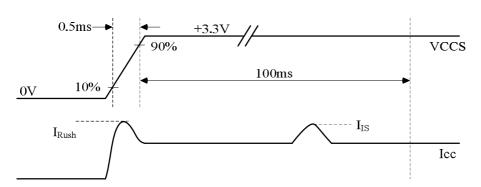
Note (2) I_{RUSH}: the maximum current when VCCS is rising

 I_{IS} : the maximum current of the first 100ms after power-on

Measurement Conditions: Shown as the following figure. Test pattern: black.



VCCS rising time is 0.5ms

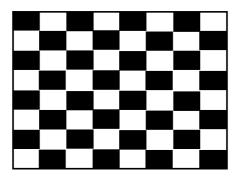


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Note (3) The specified power supply current is under the conditions at VCCS = 3.3 V, Ta = 25 \pm 2 °C, DC Current and f_v = 60 Hz, whereas a power dissipation check pattern below is displayed.

a. Mosaic Pattern



Active Area

Note (4) The specified signals have equivalent impedances pull down to ground in the LCD module respectively. Customers should keep the input signal level requirement with the load of LCD module. Please refer to Note (4) of 4.3.2 LED CONVERTER SPECIFICATION to obtain more information.

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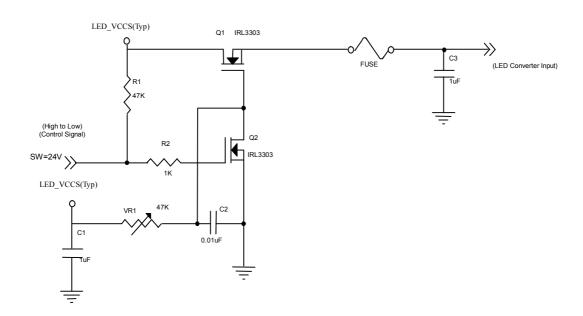
4.3.2 LED CONVERTER SPECIFICATION

Parar	motor	Cumbal		Value		Unit	Note
Falai	netei	Symbol	Min.	Тур.	Max.	Offic	Note
Converter Input Power Supply Voltage		LED_Vccs	(6.0)	(12.0)	(21.0)	V	
Converter Inrush Cu	ırrent	ILED _{RUSH}	-	-	1.5	Α	(1)
LED_EN Control	Backlight On		(2.2)	-	(5.0)	V	(4)
Level	Backlight Off		0	-	(0.6)	V	(4)
LED_EN Impedance		R _{LED_EN}	30K	-	-	ohm	(4)
PWM Control Level	PWM High Level		(2.2)	-	5	V	(4)
Pyvivi Control Level	PWM Low Level		0	-	(0.6)	V	(4)
PWM Impedance		R _{PWM}	30K	-	-	ohm	(4)
PWM Control Duty Ratio			(5)	-	100	%	
PWM Control Permissive Ripple Voltage		VPWM_pp	-	-	100	mV	
PWM Control Frequency		f _{PWM}	(190)	-	(2K)	Hz	(2)
LED Power Current	LED_VCCS =Typ.	ILED	(TBD)	(TBD)	(TBD)	mA	(3)

Note (1) ILED_{RUSH}: the maximum current when LED_VCCS is rising,

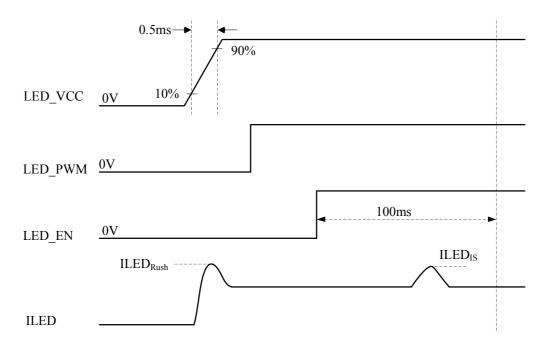
ILED_{IS}: the maximum current of the first 100ms after power-on,

Measurement Conditions: Shown as the following figure. LED_VCCS = Typ, Ta = 25 \pm 2 °C, f_{PWM} = 200 Hz, Duty=100%.





VLED rising time is 0.5ms



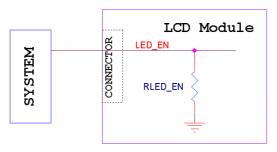
Note (2) If PWM control frequency is applied in the range less than 1KHz, the "waterfall" phenomenon on the screen may be found. To avoid the issue, it's a suggestion that PWM control frequency should follow the criterion as below.

PWM control frequency
$$f_{PWM}$$
 should be in the range $(N+0.33)*f \le f_{PWM} \le (N+0.66)*f$

N: Integer $(N \ge 3)$

f: Frame rate

- Note (3) The specified LED power supply current is under the conditions at "LED_VCCS = Typ.", Ta = 25 \pm 2 °C, f_{PWM} = 200 Hz, Duty=100%.
- Note (4) The specified signals have equivalent impedances pull down to ground in the LCD module respectively. Customers should keep the input signal level requirement with the load of LCD module. For example, the figure below describes the equivalent pull down impedance of LED_EN (If it exists). The rest pull down impedances of other signals (eg. HPD, PWM ...) are in the same concept.



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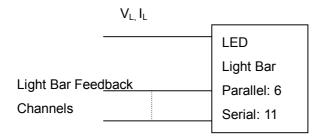


4.3.3 BACKLIGHT UNIT

Ta = 25 ± 2 °C

Devementer	Cumahal		Value		l lmi4	Note
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note (1)(2)(Duty100%)
LED Light Bar Power Supply Voltage	VL	28.6	31.9	33	V	(1)(2)(Duty(100%)
LED Light Bar Power Supply Current	ΙL		150		mA	(1)(2)(Duty 100%)
Power Consumption	PL		4.785	4.95	W	(3)
LED Life Time	L_BL	15000	-	-	Hrs	(4)

Note (1) LED current is measured by utilizing a high frequency current meter as shown below :



Note (2) For better LED light bar driving quality, it is recommended to utilize the adaptive boost converter with current balancing function to drive LED light-bar.

Note (3) $P_L = I_L \times V_L$ (Without LED converter transfer efficiency)

Note (4) The lifetime of LED is defined as the time when it continues to operate under the conditions at Ta = 25 ± 2 °C and I_L = 25 mA(Per EA) until the brightness becomes $\leq 50\%$ of its original value.

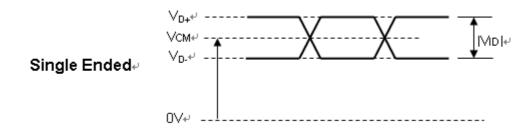


4.4 DISPLAY PORT SIGNAL TIMING SPECIFICATION

4.4.1 DISPLAY PORT INTERFACE

Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes
Differential Signal Common Mode Voltage(MainLink and AUX)	VCM	(0)		(2)	V	(1)(3)
AUX AC Coupling Capacitor	C_{AUX}	(75)		(200)	nF	(2)

- Note (1)Display port interface related AC coupled signals should follow VESA DisplayPort Standard Version1. Revision 1a and VESA Embedded DisplayPort[™] Standard Version 1.2. There are many optional items described in eDP1.2. If some optional item is requested, please contact us.
 - (2) The AUX AC Coupling Capacitor should be placed on Source Devices.
 - (3)The source device should pass the test criteria described in DisplayPortCompliance Test Specification (CTS) 1.1



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4.4.2 COLOR DATA INPUT ASSIGNMENT

The brightness of each primary color (red, green and blue) is based on the 6-bit gray scale data input for the color. The higher the binary input the brighter the color. The table below provides the assignment of color versus data input.

									[Data		al							
	Color			Re						Gre							ue		
		R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G	B5	B4	В3	B2	B1	B0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
Basic	Blue	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
Colors	Cyan	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Red(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1)	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0
Gray	Red(2)	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Red	Red(61)	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0
	Red(62)	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(63)	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Green(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(1)	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
Gray	Green(2)	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Green	Green(61)	0	0	0	0	0	0	1	1	1	1	0	1	0	0	0	0	0	0
	Green(62)	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0	0
	Green(63)	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	Blue(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
Gray	Blue(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	:	:	:	:	:	:	:	:	:	:	:	:	:		:	:	:	:	:
Blue	Blue(61)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	0	1
	Blue(62)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	0
	Blue(63)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1

Note (1) 0: Low Level Voltage, 1: High Level Voltage



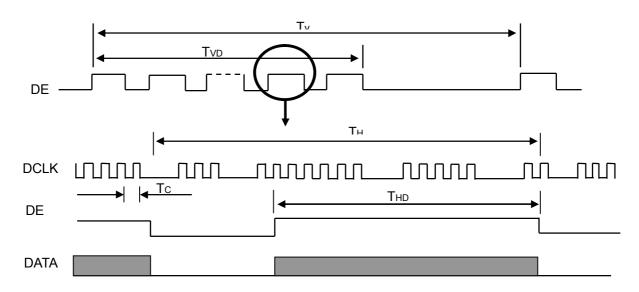
4.5 DISPLAY TIMING SPECIFICATIONS

The input signal timing specifications are shown as the following table and timing diagram.

Refresh rate 60Hz

Signal	Item	Symbol	Min.	Тур.	Max.	Unit	Note
DCLK	Frequency	1/Tc	(TBD)	(TBD)	(TBD)	MHz	-
	Vertical Total Time	TV	(TBD)	(TBD)	(TBD)	TH	-
	Vertical Active Display Period		(TBD)	(TBD)	(TBD)	TH	-
DE	Vertical Active Blanking Period	TVB	TV-TVD	(TBD)	TV-TVD	TH	-
	Horizontal Total Time	TH	(TBD)	(TBD)	(TBD)	Tc	-
	Horizontal Active Display Period		(TBD)	(TBD)	(TBD)	Tc	-
	Horizontal Active Blanking Period	THB	TH-THD	(TBD)	TH-THD	Tc	-

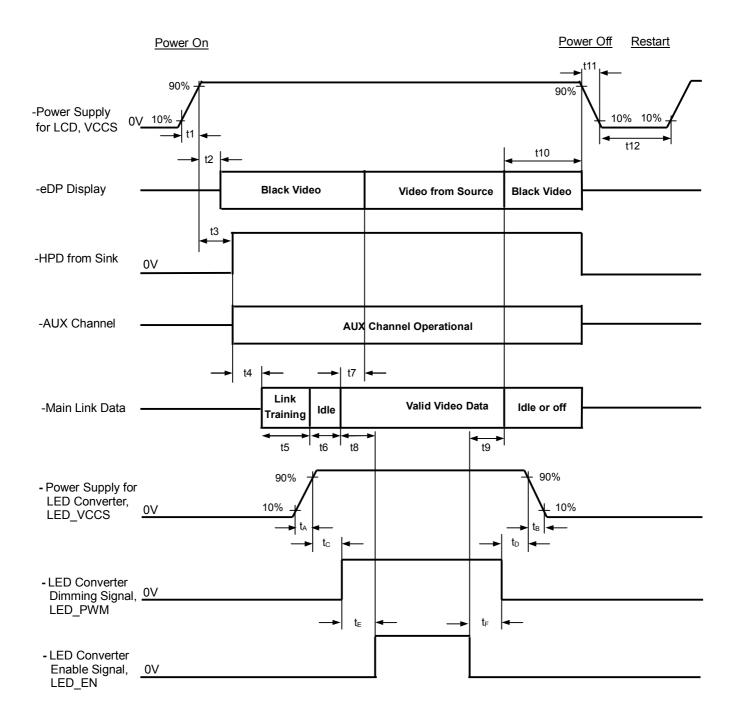
INPUT SIGNAL TIMING DIAGRAM





4.6 POWER ON/OFF SEQUENCE

The power sequence specifications are shown as the following table and diagram.





Timing Specifications:

Parameter	Description	Reqd.	Val		Unit	Notes
	·	By	Min	Max		
t1 t2	Power rail rise time, 10% to 90% Delay from LCD,VCCS to black video generation	Source Sink	0.5	200	ms ms	Automatic Black Video generation prevents display noise until valid video data is received from the Source (see Notes:2 and 3 below)
t3	Delay from LCD,VCCS to HPD high	Sink	0	200	ms	Sink AUX Channel must be operational upon HPD high (see Note:4 below)
t4	Delay from HPD high to link training initialization	Source	-	-	ms	Allows for Source to read Link capability and initialize
t5	Link training duration	Source	-	-	ms	Dependant on Source link training protocol
t6	Link idle	Source	-	-	ms	Min Accounts for required BS-Idle pattern. Max allows for Source frame synchronization
t7	Delay from valid video data from Source to video on display	Sink	0	50	ms	Max value allows for Sink to validate video data and timing. At the end of T7, Sink will indicate the detection of valid video data by setting the SINK_STATUS bit to logic 1 (DPCD 00205h, bit 0), and Sink will no longer generate automatic Black Video
t8	Delay from valid video data from Source to backlight on	Source	-	-	ms	Source must assure display video is stable
t9	Delay from backlight off to end of valid video data	Source	-	-	ms	Source must assure backlight is no longer illuminated. At the end of T9, Sink will indicate the detection of no valid video data by setting the SINK_STATUS bit to logic 0 (DPCD 00205h, bit 0), and Sink will automatically display Black Video. (See Notes: 2 and 3 below)
t10	Delay from end of valid video data from Source to power off	Source	0	500	ms	Black video will be displayed after receiving idle or off signals from Source
t11	VCCS power rail fall time, 90% to 10%	Source	0.5	10	ms	-
t12	VCCS Power off time	Source	500	-	ms	-
t _A	LED power rail rise time, 10% to 90%	Source	0.5	10	ms	-
t _B	LED power rail fall time, 90% to 10%	Source	0	10	ms	-

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t _C	Delay from LED power rising to LED dimming signal	Source	1	-	ms	-
t _D	Delay from LED dimming signal to LED power falling	Source	1	-	ms	-
t _∈	Delay from LED dimming signal to LED enable signal	Source	1	-	ms	-
t _F	Delay from LED enable signal to LED dimming signal	Source	1	-	ms	-

- Note (1) Please don't plug or unplug the interface cable when system is turned on.
- Note (2) The Sink must include the ability to automatically generate Black Video autonomously. The Sink must automatically enable Black Video under the following conditions:
 - Upon LCDVCC power-on (within T2 max)
 - When the "NoVideoStream Flag" (VB-ID Bit 3) is received from the Source (at the end of T9)
 - When no Main Link data, or invalid video data, is received from the Source. Black Video must be displayed within 50ms (max) from the start of either condition. Video data can be deemed invalid based on MSA and timing information, for example.
- Note (3) The Sink may implement the ability to disable the automatic Black Video function, as described in Note (2), above, for system development and debugging purposes.
- Note (4) The Sink must support AUX Channel polling by the Source immediately following LCDVCC power-on without causing damage to the Sink device (the Source can re-try if the Sink is not ready). The Sink must be able to response to an AUX Channel transaction with the time specified within T3 max.

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5. OPTICAL CHARACTERISTICS

5.1 TEST CONDITIONS

Item	Symbol	Value	Unit				
Ambient Temperature	Та	25±2	°C				
Ambient Humidity	На	50±10	%RH				
Supply Voltage	V _{CC}	3.3	V				
Input Signal	According to typical value in "3. ELECTRICAL CHARACTERISTICS"						
LED Light Bar Input Current	IL	150	mA				

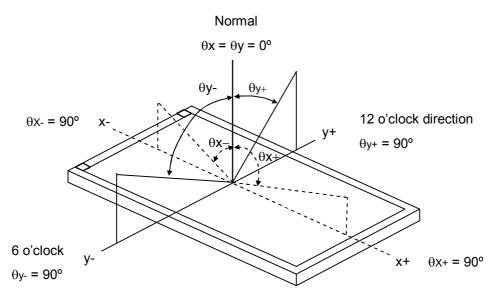
The measurement methods of optical characteristics are shown in Section 5.2. The following items should be measured under the test conditions described in Section 5.1 and stable environment shown in Note (5).

5.2 OPTICAL SPECIFICATIONS

Iter	m	Symbol	Condition	Min.	Тур.	Max.	Unit	Note
Contrast Ratio		CR		500	700	-	-	(2), (5),(7)
Response Time		T _R		-	14	19	ms	
		T_F		-	11	16	ms	(3),(7)
Average Lumina	ance of White	Lave		255	300	-	cd/m ²	(4), (6),(7)
	Red	Rx	$\theta_{x}=0^{\circ}, \ \theta_{Y}=0^{\circ}$		TBD		-	
	ixeu	Ry	Viewing Normal Angle		TBD		-	
Color	Green	Gx			TBD		-	
	Green	Gy		Тур –	TBD	Typ +	-	(1),(7)
Chromaticity	Dlue	Bx		0.03	TBD	0.03	-	
	Blue	Ву			TBD		-	
	White	Wx			0.313		-	
	vvriite	Wy			0.329		-	
	l lovi-ontol	θ_x +		80	89			
Violeina Anglo	Horizontal	θ _x -	OD: 40	80	89	-	Dog	(1),(5),
Viewing Angle	Vertical	θ _Y +	CR≥10	80	89	-	Deg.	(7)
Vertical		θ _Y -		80	89	-		
White Variation	of 5 Points	δW _{5p}	θ _x =0°, θ _Y =0°	80	-	-	%	(5),(6) , (7)



Note (1) Definition of Viewing Angle (θx , θy):



Note (2) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) = L63 / L0

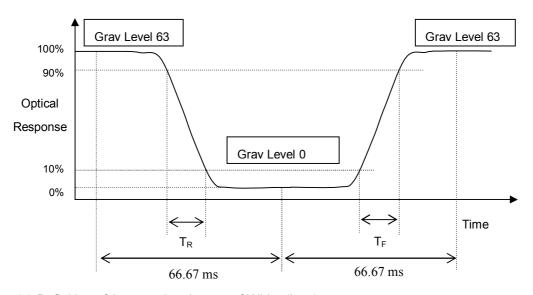
L63: Luminance of gray level 63

L 0: Luminance of gray level 0

CR = CR(1)

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (6).

Note (3) Definition of Response Time (T_R, T_F) :



Note (4) Definition of Average Luminance of White (L_{AVE}):

Measure the luminance of White at 5 points

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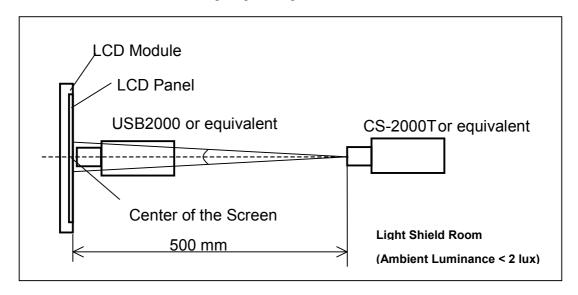


 $L_{AVE} = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$

L (x) is corresponding to the luminance of the point X at Figure in Note (6)

Note (5) Measurement Setup:

The LCD module should be stabilized at given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room.



Note (6) Definition of White Variation (δW):

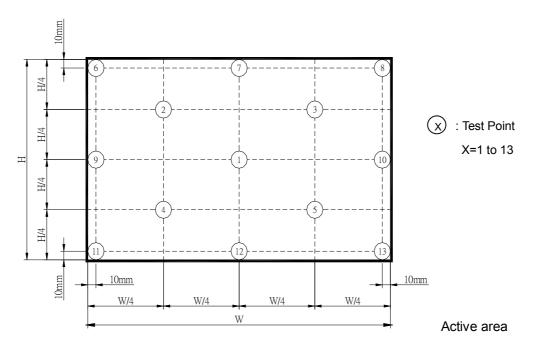
Measure the luminance of White at 5 points / 13 points

 $\delta W_{5p} = \{Minimum [L (1)\sim L (5)] / Maximum [L (1)\sim L (5)]\}*100\%$

 $\delta W_{13p} = \{Minimum [L (1) \sim L (13)] / Maximum [L (1) \sim L (13)]\}*100\%$

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Note (7) The listed optical specifications refer to the initial value of manufacture, but the condition of the specifications after long-term operation will not be warranted.

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6. RELIABILITY TEST ITEM

Test Item	Test Condition	Note
High Temperature Storage Test	60°C, 240 hours	
Low Temperature Storage Test	-20°C, 240 hours	
Thermal Shock Storage Test	-20°C, 0.5hour ←→60°C, 0.5hour; 100cycles, 1hour/cycle	
High Temperature Operation Test	50°C, 240 hours	(1) (2)
Low Temperature Operation Test	0°C, 240 hours	
High Temperature & High Humidity Operation Test	50°C, 80% RH, 240 hours	
ESD Test (Operation)	150pF, 330 Ω , 1sec/cycle Condition 1 : Contact Discharge, ± 8 KV Condition 2 : Air Discharge, ± 15 KV	(1)
Shock (Non-Operating)	220G, 2ms, half sine wave,1 time for each direction of ±X,±Y,±Z	(1)(3)
Vibration (Non-Operating)	1.5G / 10-500 Hz, Sine wave, 30 min/cycle, 1cycle for each X, Y, Z	(1)(3)

Note (1) criteria: Normal display image with no obvious non-uniformity and no line defect.

Note (2) Evaluation should be tested after storage at room temperature for more than two hour

Note (3) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.



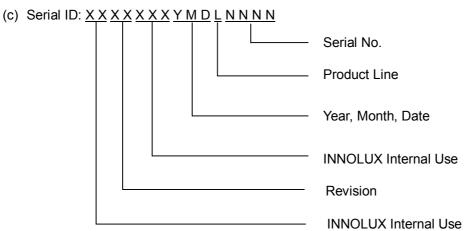
7. PACKING

7.1 MODULE LABEL

The barcode nameplate is pasted on each module as illustration, and its definitions are as following explanation.



- (a) Model Name: N173HCE E31
- (b) Revision: Rev. XX, for example: C1, C2 ...etc.



Serial ID includes the information as below:

(a) Manufactured Date: Year: 0~9, for 2010~2019

Month: 1~9, A~C, for Jan. ~ Dec.

Day: 1~9, A~Y, for 1st to 31st, exclude I, O and U

- (b) Revision Code: cover all the change
- (c) Serial No.: Manufacturing sequence of product
- (d) Product Line: 1 -> Line1, 2 -> Line 2, ...etc.



7.2 CARTON

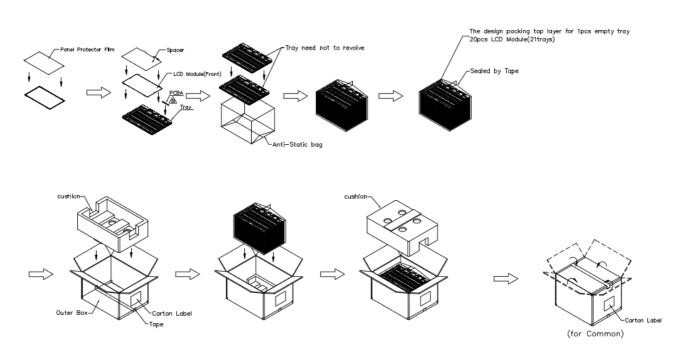


Figure. 7-2 Packing method



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7.3 PALLET

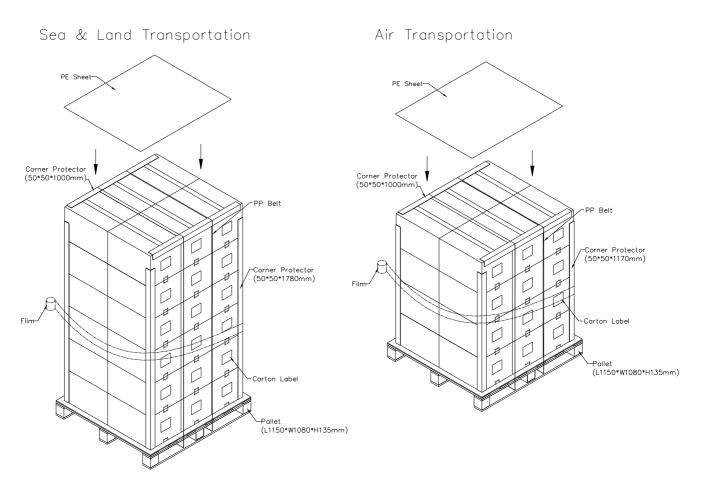
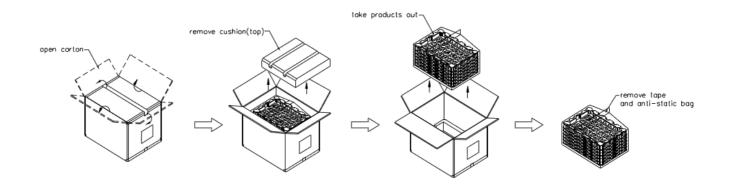


Figure. 7-3 Packing method



7.4 UN-PACKAGING METHOD



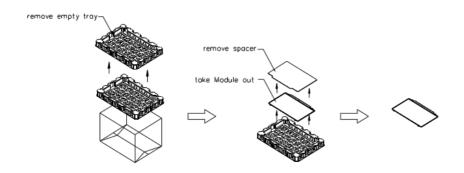


Figure. 7.4 Un-packing method

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8. PRECAUTIONS

8.1 HANDLING PRECAUTIONS

- (1) The module should be assembled into the system firmly by using every mounting hole. Be careful not to twist or bend the module.
- (2) While assembling or installing modules, it can only be in the clean area. The dust and oil may cause electrical short or damage the polarizer.
- (3) Use fingerstalls or soft gloves in order to keep display clean during the incoming inspection and assembly process.
- (4) Do not press or scratch the surface harder than a HB pencil lead on the panel because the polarizer is very soft and easily scratched.
- (5) If the surface of the polarizer is dirty, please clean it by some absorbent cotton or soft cloth. Do not use Ketone type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanently damage the polarizer due to chemical reaction.
- (6) Wipe off water droplets or oil immediately. Staining and discoloration may occur if they left on panel for a long time.
- (7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contacting with hands, legs or clothes, it must be washed away thoroughly with soap.
- (8) Protect the module from static electricity, it may cause damage to the C-MOS Gate Array IC.
- (9) Do not disassemble the module.
- (10) Do not pull or fold the LED wire.
- (11) Pins of I/F connector should not be touched directly with bare hands.

8.2 STORAGE PRECAUTIONS

- (1) High temperature or humidity may reduce the performance of module. Please store LCD module within the specified storage conditions.
- (2) It is dangerous that moisture come into or contacted the LCD module, because the moisture may damage LCD module when it is operating.
- (3) It may reduce the display quality if the ambient temperature is lower than 10 °C. For example, the response time will become slowly, and the starting voltage of LED will be higher than the room temperature.

8.3 OPERATION PRECAUTIONS

- (1) Do not pull the I/F connector in or out while the module is operating.
- (2) Always follow the correct power on/off sequence when LCD module is connecting and operating. This can prevent the CMOS LSI chips from damage during latch-up.
- (3) The startup voltage of Backlight is approximately 1000 Volts. It may cause electrical shock while assembling with converter. Do not disassemble the module or insert anything into the Backlight unit.



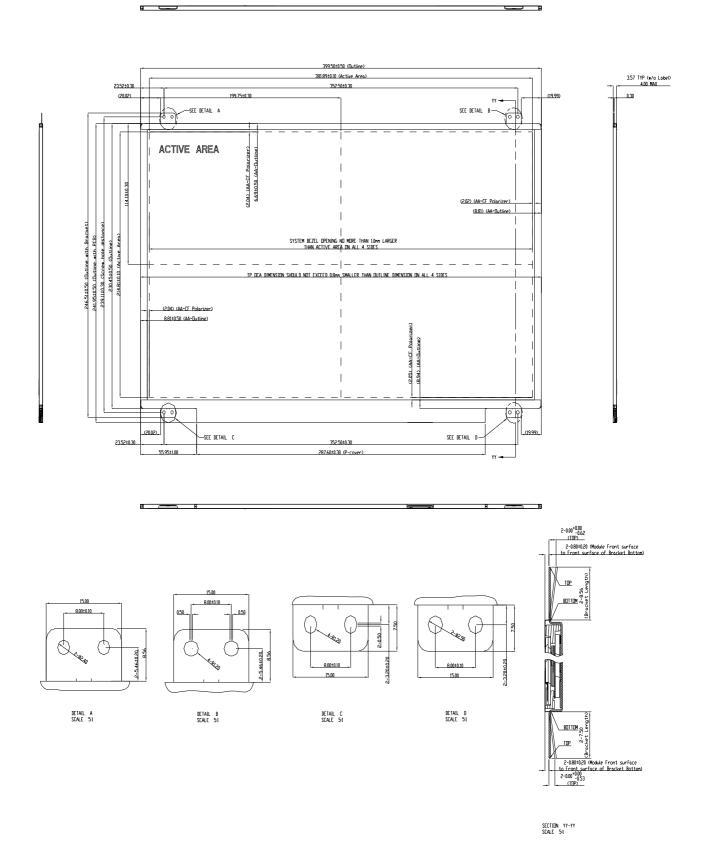
Appendix. EDID DATA STRUCTURE

The EDID (Extended Display Identification Data) data formats are to support displays as defined in the VESA Plug & Display and FPDI standards.

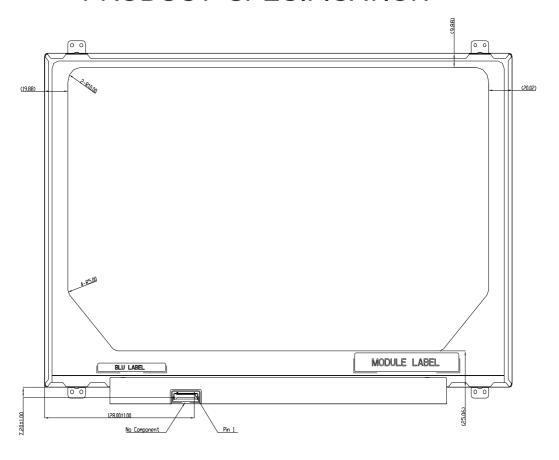
TBD

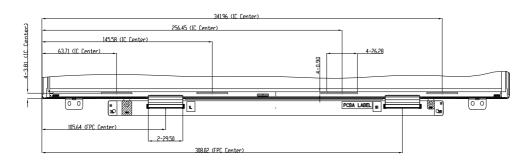


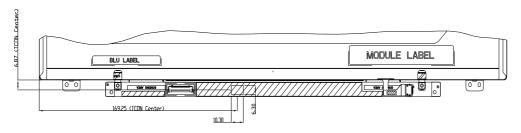
Appendix. OUTLINE DRAWING











DRIVER IC, COF/FPC, TCON, AND VR LOCATIONS SEE NOTES FOR EXPLANATION

- NOTES:

 1. LCD MIDULE INPUT CONNECTOR: 1-PEX 20455-030E-12 OR TYCO 5-2069716-2.

 2. IN DRICK TO AVOID ABNORMAL DISPLAY, POOLING AND WHITE SPOT,

 NO DIVERLAPPING IS SUGGESTED AT CABLES, ANTENNAS, CAMERA, VLAN, VAN OR
 FOREIGN DELECTS DIVER FPCOLIF 1-TCO. NAID VR. DICATIONS.

 2. LVDS/CEP CONNECTOR IS MEASURED AT PINI AND ITS MATING LINE.

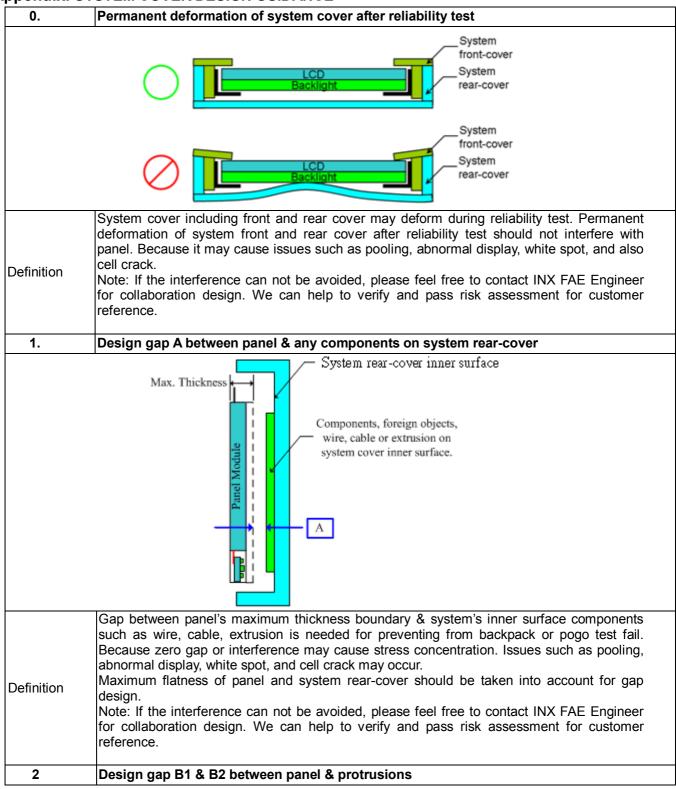
 MIDULE FLANTASS SPEC 2004 MM AMX. (SPEC. VILL BE MODIFIED AFTER DVT CHECK).

 5. '()' MARKS THE REFERENCE DIMENSION.

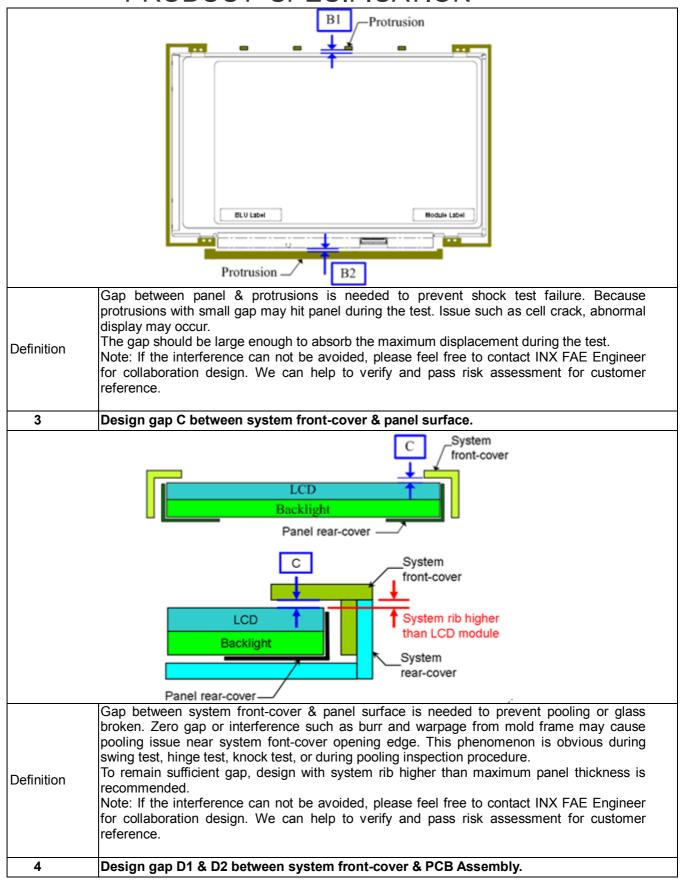
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Appendix. SYSTEM COVER DESIGN GUIDANCE

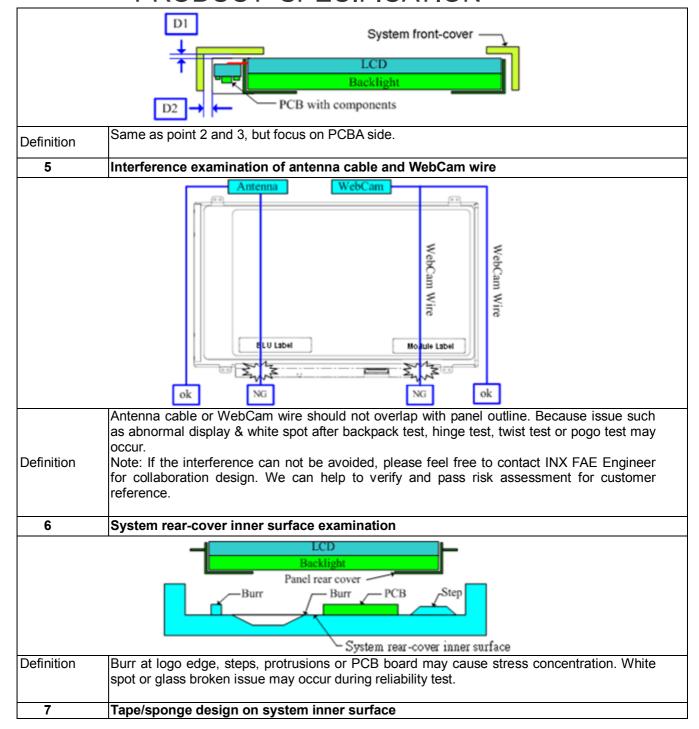




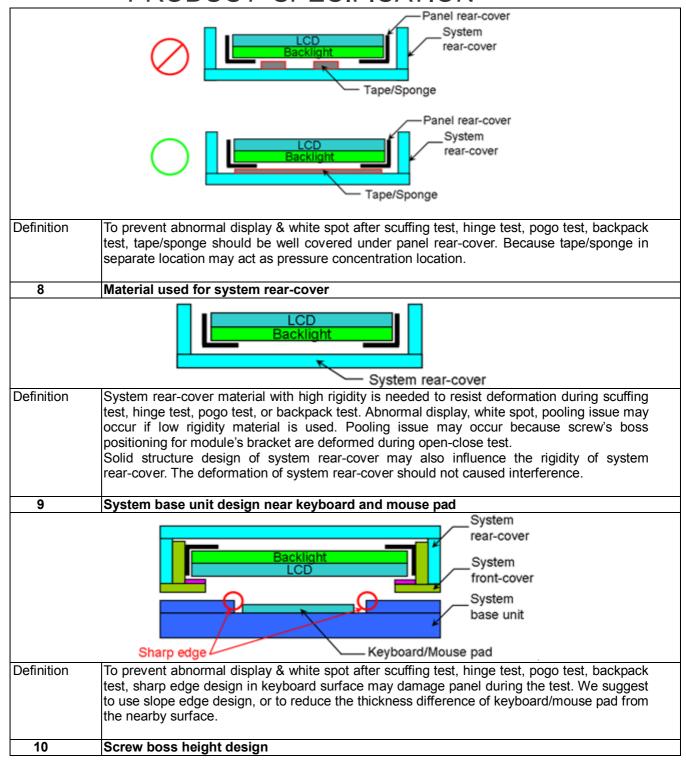


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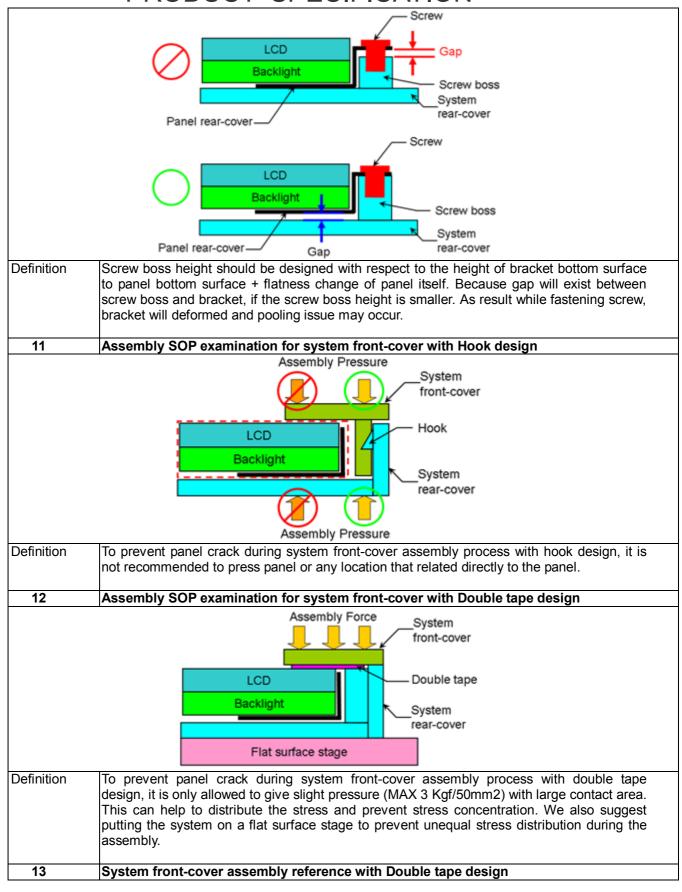




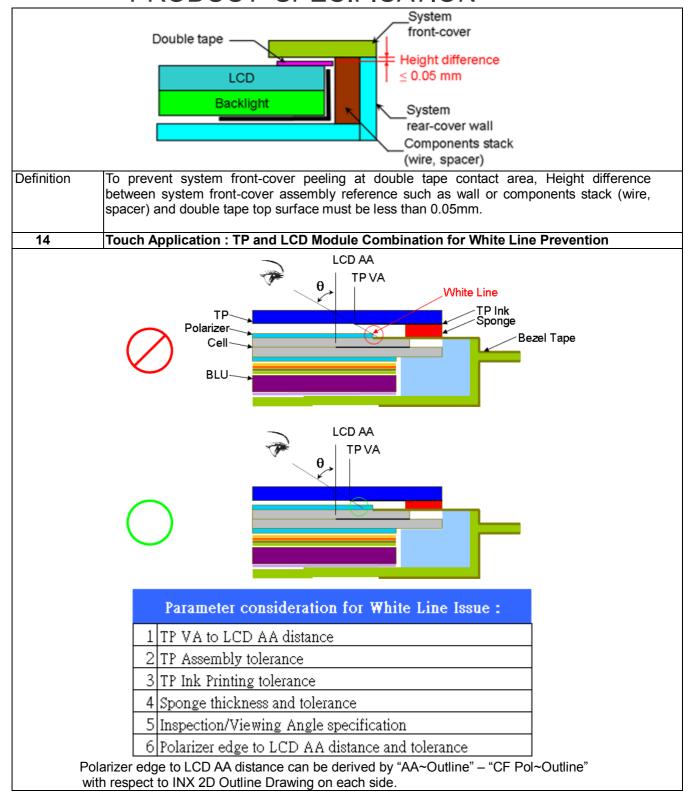




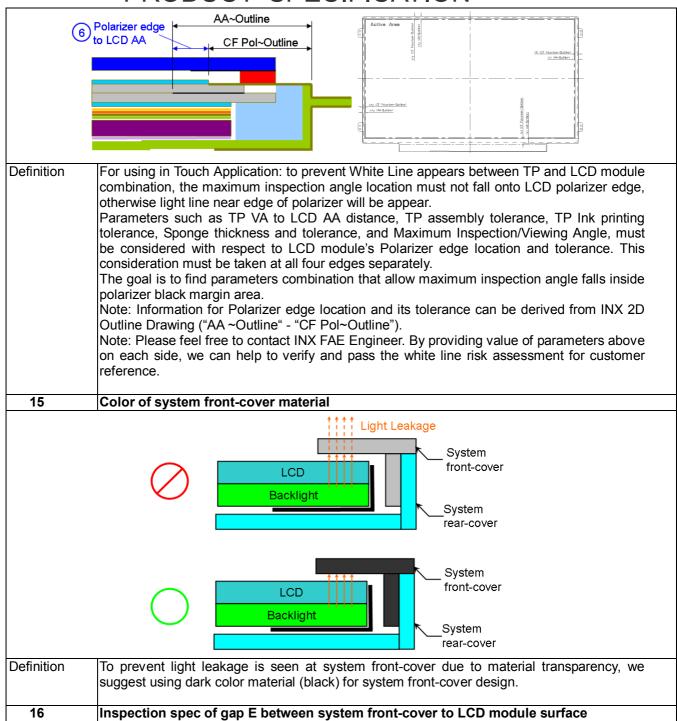




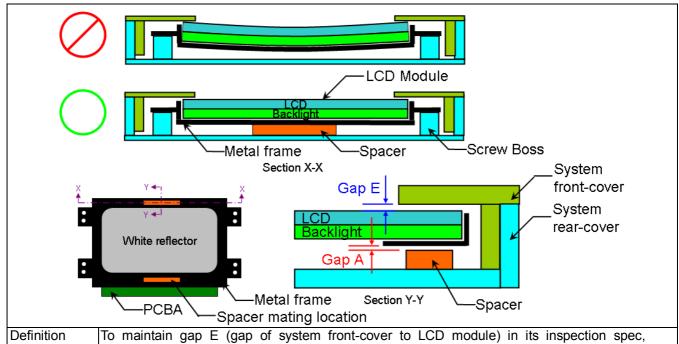












To maintain gap E (gap of system front-cover to LCD module) in its inspection spec, especially at location with maximum LCD deformation (center of LCD length), we recommend adding spacer with design gap A smaller or equal to gap E.

The allowable spacer mating location is on module metal frame outside LCD Active-Area. Note: If the interference can not be avoided, please feel free to contact INX FAE Engineer for collaboration design. We can help to verify and pass risk assessment for customer reference.



Appendix. LCD MODULE HANDLING MANUAL

Purpose	 This SOP is prepared to prevent panel dysfunction possibility through incorrect handling procedure. This manual provides guide in unpacking and handling steps. Any person which may contact / related with panel, should follow guide stated in this manual to prevent panel loss.
1.	Unpacking

Open carton

Remove EPE Cushion















Open plastic bag

Cut Adhesive Tape

Remove EPE Cushion

2.

Panel Lifting



Remove PET Cover

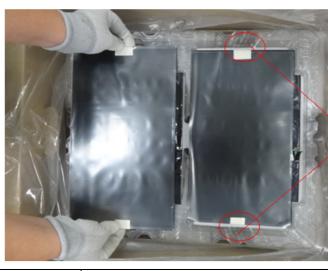


Remove PE Foam



Handle with care (see next page)





Finger Slot

Use slots at both sides for finger insertion. Handle panel upward with care.

3.

Do and Don't



Do:

- Handle with both hands.
- Handle panel at left and right edge.



Don't:

- Lifting with one hand.



Handle at PCBA side.



Don't:

- Stack panels.



- Press panel.



Don't:

- Put foreign stuff onto panel



- Put foreign stuff under panel



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Don't:

 Paste any material unto white reflector sheet



Don't:

 Pull / Push white reflector sheet



Don't:

Hold at panel corner.



Don't:

- Twist panel.





Do:

 Hold panel at top edge while inserting connector.



Don't:

 Press white reflector sheet while inserting connector.



Do:

 Remove panel protector film starts from side tape.



Don't:

 Remove panel protector film from film corner directly before side tape is removed.





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Don't:

- Touch or Press PCBA Area.



